

# SANYO Semiconductors DATA SHEET

An ON Semiconductor Company

N-Channel Silicon MOSFET

# **EFC6602R** — Lithium-ion battery charging and discharging switch

#### **Features**

- 2.5V drive
- · Common-drain type
- · 2KV ESD HBM

- · Protection diode in
- · Halogen free compliance

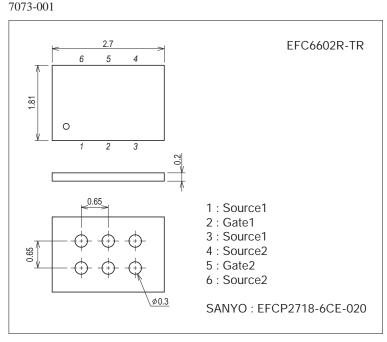
# **Specifications**

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Source-to-Source Voltage	V <sub>SSS</sub>		12	V
Gate-to-Source Voltage	VGSS		±12	V
Source Current (DC)	IS		18	Α
Source Current (Pulse)	ISP	PW≤10μs, duty cycle≤1%	60	Α
Total Dissipation	PT	When mounted on ceramic substrate (5000mm <sup>2</sup> ×0.8mm)	2.0	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C

## **Package Dimensions**

unit: mm (typ)



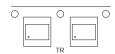
# **Product & Package Information**

• Package : EFCP

• JEITA, JEDEC :-

• Minimum Packing Quantity : 5,000 pcs./reel

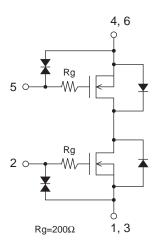
#### Taping Type: TR



#### Marking



#### **Electrical Connection**



http://www.sanyosemi.com/en/network/

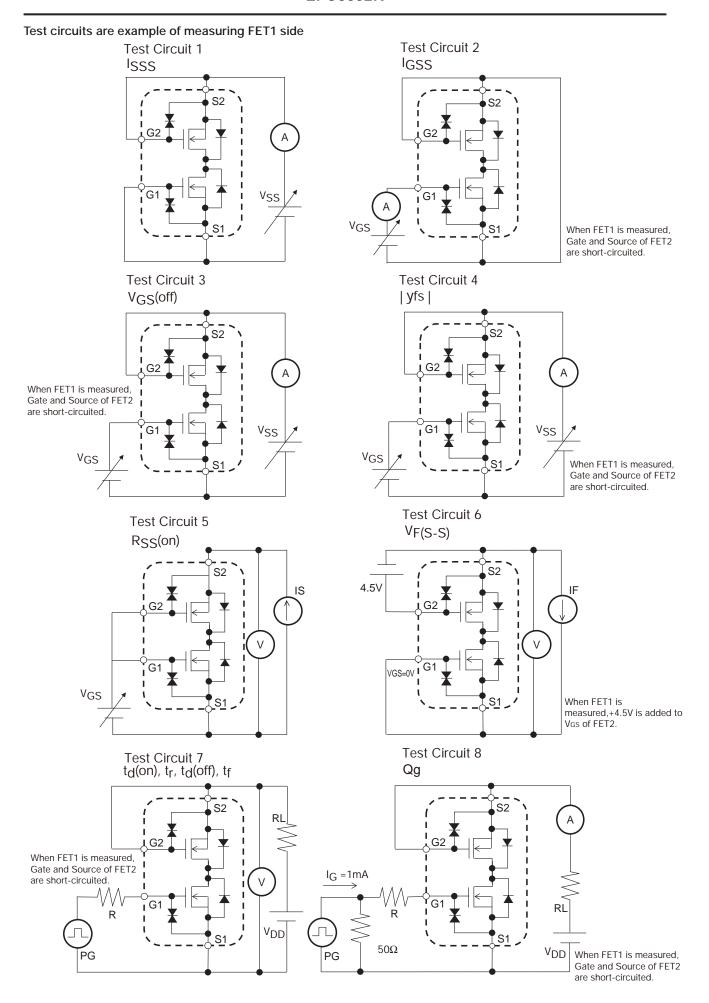
# EFC6602R

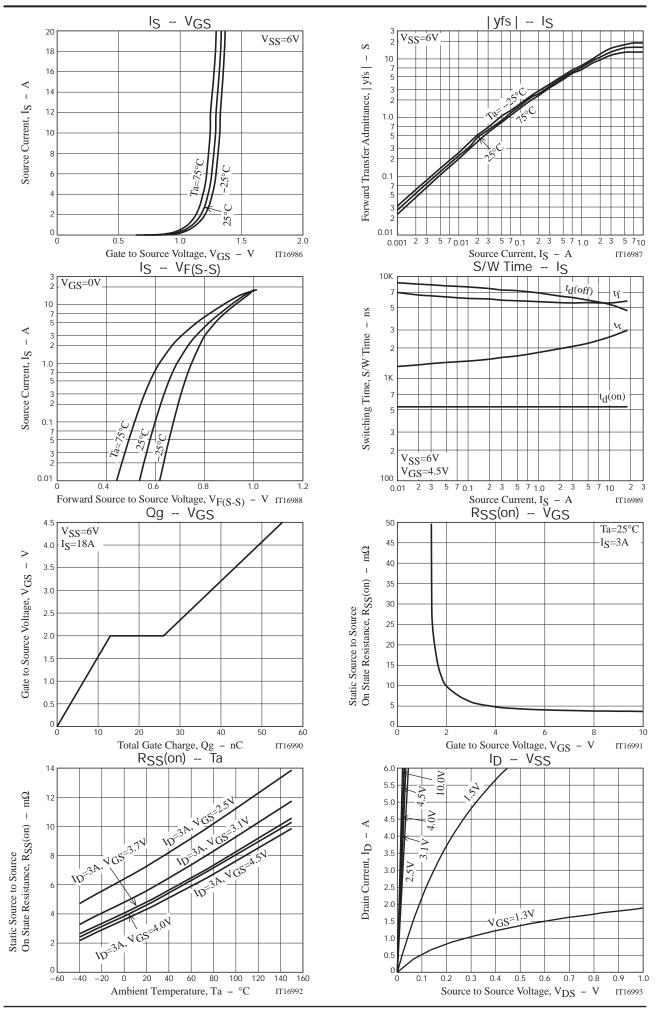
# Electrical Characteristics at Ta=25°C

Parameter	Cumbal	Conditions		Ratings			1114
Parameter	Symbol			min	typ	max	Unit
Source-to-Source Breakdown Voltage	V(BR)SSS	IS=1mA, VGS=0V	Test Circuit 1	12			V
Zero-Gate Voltage Source Current	ISSS	V <sub>SS</sub> =10V, V <sub>GS</sub> =0V	Test Circuit 1			1	μΑ
Gate-to-Source Leakage Current	IGSS	VGS=±8V, VSS=0V	Test Circuit 2			±1	μΑ
Cutoff Voltage	VGS(off)	VSS=6V, IS=1mA	Test Circuit 3	0.5		1.3	V
Forward Transfer Admittance	yfs	VSS=6V, IS=3A	Test Circuit 4		13		S
	R <sub>SS</sub> (on)1	IS=3A, VGS=4.5V	Test Circuit 5	3.1	4.5	5.9	mΩ
	RSS(on)2	IS=3A, VGS=4.0V	Test Circuit 5	3.3	4.8	6.3	mΩ
Static Source-to-Source On-State Resistance	RSS(on)3	IS=3A, VGS=3.8V	Test Circuit 5	3.5	5	6.5	mΩ
	RSS(on)4	IS=3A, VGS=3.1V	Test Circuit 5	4.0	5.8	8.2	mΩ
	RSS(on)5	IS=3A, VGS=2.5V	Test Circuit 5	5.2	7.5	11	mΩ
Turn-ON Delay Time	t <sub>d</sub> (on)		Test Circuit 7		530		ns
Rise Time	t <sub>r</sub>	\\ (\\ \\ 1 \\ \\ 1 \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \			2100		ns
Turn-OFF Delay Time	t <sub>d</sub> (off)	V <sub>DD</sub> =6V, V <sub>GS</sub> =4.5V, I <sub>S</sub> =3A			6200		ns
Fall Time	tf				5500		ns
Total Gate Charge	Qg	V <sub>DD</sub> =6V, V <sub>GS</sub> =4.5V, I <sub>S</sub> =18A	Test Circuit 8		55		nC
Forward Source-to-Source Voltage	V <sub>F</sub> (S-S)	I <sub>S</sub> =3A, V <sub>GS</sub> =0V	Test Circuit 6		0.76	1.2	V

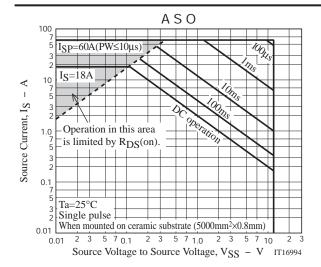
# Ordering Information

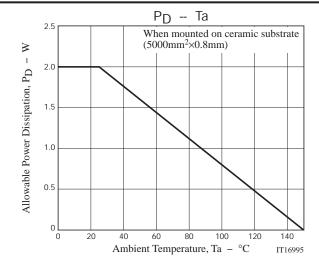
Device	Package	Shipping	memo	
EFC6602R-TR	EFCP	5,000pcs./reel	Pb Free and Halogen Free	





# EFC6602R



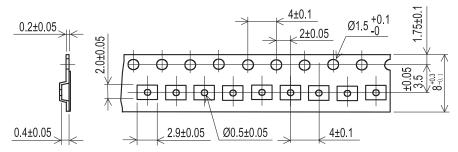


# **Taping Specification**

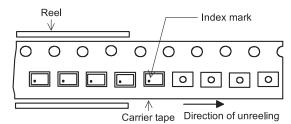
#### EFC6602R-TR

## 1. Taping Configuration

## 1-1 .Carrier Tape Size (unit:mm)

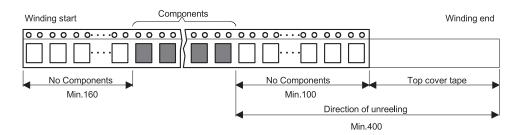


# 1-2 .Device Placement Direction



Packing type····TR

## 1-3 .Leader portion and Trailer portion (unit:mm)

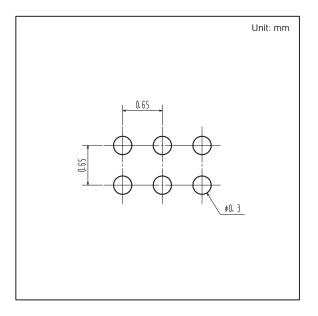


# Outline Drawing

EFC6602R-TR

# 

# Land Pattern Example



Note on usage: Since the EFC6602R is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

- Any and all SANYO Semiconductor Co.,Ltd. products described or contained herein are, with regard to "standard application", intended for the use as general electronics equipment. The products mentioned herein shall not be intended for use for any "special application" (medical equipment whose purpose is to sustain life, aerospace instrument, nuclear control device, burning appliances, transportation machine, traffic signal system, safety equipment etc.) that shall require extremely high level of reliability and can directly threaten human lives in case of failure or malfunction of the product or may cause harm to human bodies, nor shall they grant any guarantee thereof. If you should intend to use our products for new introduction or other application different from current conditions on the usage of automotive device, communication device, office equipment, industrial equipment etc., please consult with us about usage condition (temperature, operation time etc.) prior to the intended use. If there is no consultation or inquiry before the intended use, our customer shall be solely responsible for the use.
- Specifications of any and all SANYO Semiconductor Co.,Ltd. products described or contained herein stipulate the performance, characteristics, and functions of the described products in the independent state, and are not guarantees of the performance, characteristics, and functions of the described products as mounted in the customer's products or equipment. To verify symptoms and states that cannot be evaluated in an independent device, the customer should always evaluate and test devices mounted in the customer's products or equipment.
- SANYO Semiconductor Co.,Ltd. assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all SANYO Semiconductor Co.,Ltd. products described or contained herein.
- Regarding monolithic semiconductors, if you should intend to use this IC continuously under high temperature, high current, high voltage, or drastic temperature change, even if it is used within the range of absolute maximum ratings or operating conditions, there is a possibility of decrease reliability. Please contact us for a confirmation
- SANYO Semiconductor Co.,Ltd. strives to supply high-quality high-reliability products, however, any and all semiconductor products fail or malfunction with some probability. It is possible that these probabilistic failures or malfunction could give rise to accidents or events that could endanger human lives, trouble that could give rise to smoke or fire, or accidents that could cause damage to other property. When designing equipment, adopt safety measures so that these kinds of accidents or events cannot occur. Such measures include but are not limited to protective circuits and error prevention circuits for safe design, redundant design, and structural design.
- In the event that any or all SANYO Semiconductor Co.,Ltd. products described or contained herein are controlled under any of applicable local export control laws and regulations, such products may require the export license from the authorities concerned in accordance with the above law.
- No part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, including photocopying and recording, or any information storage or retrieval system, or otherwise, without the prior written consent of SANYO Semiconductor Co.,Ltd.
- Any and all information described or contained herein are subject to change without notice due to product/technology improvement, etc. When designing equipment, refer to the "Delivery Specification" for the SANYO Semiconductor Co.,Ltd. product that you intend to use.
- Upon using the technical information or products described herein, neither warranty nor license shall be granted with regard to intellectual property rights or any other rights of SANYO Semiconductor Co.,Ltd. or any third party. SANYO Semiconductor Co.,Ltd. shall not be liable for any claim or suits with regard to a third party's intellectual property rights which has resulted from the use of the technical information and products mentioned above.

This catalog provides information as of November, 2012. Specifications and information herein are subject to change without notice.